

PXE30-xxDxx Dual Output DC/DC Converter

9 to 18 Vdc , 18 to 36 Vdc , or 36 to 75 Vdc input, 12 to 15 Vdc Dual Output, 30W



APPLICATIONS

Wireless Network
Telecom/Datacom
Industry Control System
Measurement Equipment
Semiconductor Equipment

Features

- 30 watts maximum output power
- Output current up to 1250mA
- Standard 2" x 1.6" x 0.4" package
- High efficiency up to 88%
- 2:1 wide input voltage range
- Six-sided continuous shield
- Fixed switching frequency
- CE MARK meets 2006/95/EC, 93/68/EEC and 2004/108/EC
- UL60950-1, EN60950-1 and IEC60950-1 licensed
- ISO9001 certified manufacturing facilities
- Compliant to RoHS EU directive 2002/95/EC

Options

- Heat sinks available for extended operation

General Description

The PXE30-xxDxx series offers 30 watts of output power in a 2 x 1.6 x 0.4 inch package . This series has a 2:1 wide input voltage of 9-18VDC, 18-36VDC or 36-75VDC and features 1600VDC of isolation, short-circuit and over-voltage protection.

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| Absolute Maximum Rating | | | | |
|----------------------------------------------------------------|-------------------|-------|-----|----------|
| Parameter | Model | Min | Max | Unit |
| Input Voltage | Continuous | 12Dxx | 18 | V_{DC} |
| | | 24Dxx | 36 | |
| | | 48Dxx | 75 | |
| | Transient (100mS) | 12Dxx | 36 | |
| | | 24Dxx | 50 | |
| | | 48Dxx | 100 | |
| Input Voltage Variation (complies with EST300 132 part 4.4) | All | | 5 | V/mS |
| Operating Ambient Temperature (with derating) | All | -40 | 85 | °C |
| Operating Case Temperature | All | | 100 | °C |
| Storage Temperature | All | -55 | 105 | °C |

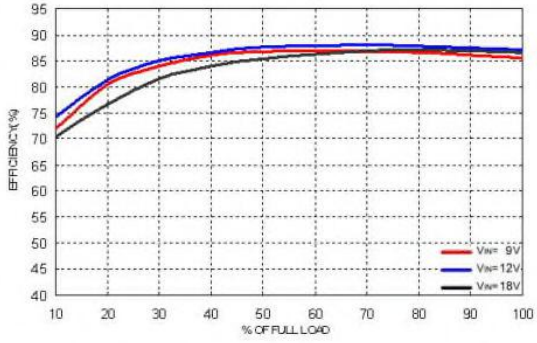
| Output Specification | | | | | |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----------------------------|-----|------------|---------------|
| Parameter | Model | Min | Typ | Max | Unit |
| Output Voltage ($V_{in} = V_{in(nom)}$; Full Load ; $T_A=25^\circ\text{C}$) | xxD12 | 11.88 | 12 | 12.12 | V_{DC} |
| | xxD15 | 14.85 | 15 | 15.15 | |
| Voltage Adjustability | All | -10 | | +10 | % |
| Output Regulation Line ($V_{in(min)}$ to $V_{in(max)}$ at Full Load) Load (Min. to 100% of Full Load) | All | -0.5 | | +0.5 | % |
| | | -1 | | +1 | |
| Output Ripple & Noise Peak-to-Peak (20MHz bandwidth) (Measured with a 0.1 μF /50V MLCC) | xxD12 | | 100 | | mVp-p |
| | xxD15 | | 100 | | |
| Temperature Coefficient | All | -0.02 | | +0.02 | %/°C |
| Output Voltage Overshoot ($V_{in(min)}$ to $V_{in(max)}$; Full Load ; $T_A=25^\circ\text{C}$) | All | | 0 | 5 | % V_{OUT} |
| Dynamic Load Response ($V_{in} = V_{in(nom)}$; $T_A=25^\circ\text{C}$) Load step change from 75% to 100% or 100 to 75% of Full Load Peak Deviation Setting Time ($V_{OUT} < 10\%$ peak deviation) | All | | 250 | | mV |
| | All | | 300 | | μS |
| | | | | | |
| Output Current | xxD12 | 0 | | ± 1250 | mA |
| | xxD15 | 0 | | ± 1000 | |
| Output Over Voltage Protection (Zener diode clamp) | xxD12 | | 15 | | V_{DC} |
| | xxD15 | | 18 | | |
| Output Over Current Protection | All | | | 150 | % FL. |
| Output Short Circuit Protection | All | Hiccup, automatic recovery | | | |

| Input Specification | | | | | |
|-------------------------------------------------------------------------------|-------------------------|------|-----|------|----------|
| Parameter | Model | Min | Typ | Max | Unit |
| Operating Input Voltage | 12Dxx | 9 | 12 | 18 | V_{DC} |
| | 24Dxx | 18 | 24 | 36 | |
| | 48Dxx | 36 | 48 | 75 | |
| Input Current (Maximum value at $V_{in} = V_{in(nom)}$; Full Load) | 12D12 | | | 3012 | mA |
| | 12D15 | | | 3012 | |
| | 24D12 | | | 1488 | |
| | 24D15 | | | 1488 | |
| | 48D12 | | | 744 | |
| | 48D15 | | | 744 | |
| Input Standby Current (Typical value at $V_{in} = V_{in(nom)}$; No Load) | 12D12 | | 60 | | mA |
| | 12D15 | | 40 | | |
| | 24D12 | | 30 | | |
| | 24D15 | | 30 | | |
| | 48D12 | | 20 | | |
| | 48D15 | | 20 | | |
| Under Voltage Lockout Turn-on Threshold | 12Dxx | | | 9 | V_{DC} |
| | 24Dxx | | | 17.8 | |
| | 48Dxx | | | 36 | |
| Under Voltage Lockout Turn-off Threshold | 12Dxx | | 8 | | V_{DC} |
| | 24Dxx | | 16 | | |
| | 48Dxx | | 33 | | |
| Input Reflected Ripple Current (5 to 20MHz, 12 μ H Source Impedance) | All | | 30 | | mAp-p |
| Start Up Time ($V_{in} = V_{in(nom)}$ and Constant Resistive Load) | | | | | mS |
| | Power Up | All | | 25 | |
| | Remote ON/OFF | | | 25 | |
| Remote ON/OFF Control (The ON/OFF pin voltage is referenced to $-V_{IN}$) | | | | | V_{DC} |
| | Positive Logic DC-DC ON | All | 3.0 | 12 | |
| | DC-DC OFF | | 0 | 1.2 | |
| Remote Off Input Current | All | | 2.5 | | mA |
| Input Current of Remote Control Pin | All | -0.5 | | 0.5 | mA |

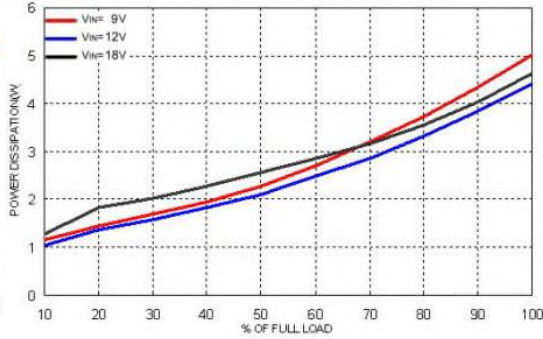
| General Specification | | | | | |
|--------------------------------------------------------------------------|-------|--------------|--------------------------------------------|------|-------------|
| Parameter | Model | Min | Typ | Max | Unit |
| Efficiency ($V_{in} = V_{in(nom)}$; Full Load ; $T_A=25^{\circ}C$) | 12D12 | | 87 | | % |
| | 12D15 | | 87 | | |
| | 24D12 | | 88 | | |
| | 24D15 | | 88 | | |
| | 48D12 | | 88 | | |
| | 48D15 | | 88 | | |
| Isolation Voltage Input to Output Input to Case, Output to Case | All | 1600 1600 | | | V_{DC} |
| Isolation Resistance | All | 1 | | | G Ω |
| Isolation Capacitance | All | | | 1000 | pF |
| Switching Frequency | All | | 300 | | kHz |
| Weight | All | | 48 | | g |
| MTBF Bellcore TR-NWT-000332, $T_C=40^{\circ}C$ MIL-HDBK-217F | All | | 1.316×10^6 3.465×10^5 | | hours |
| Over Temperature Protection | All | | 115 | | $^{\circ}C$ |

Characteristic Curves

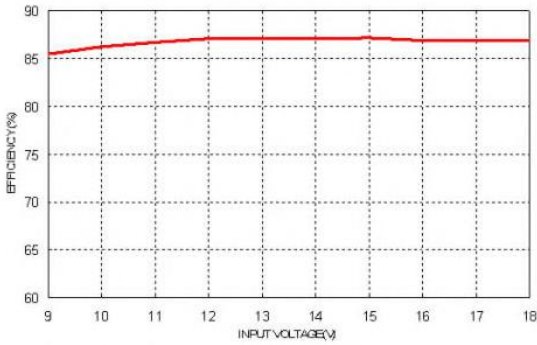
All test conditions are at 25°C. The figures are for PXE30-12D12



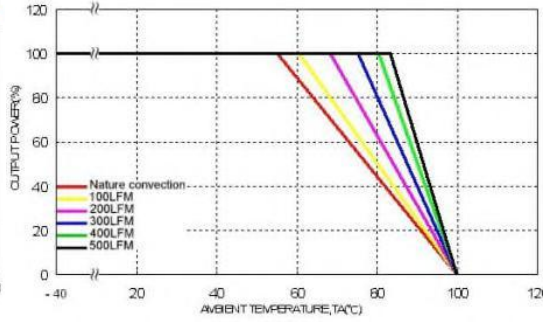
Efficiency Versus Output Current



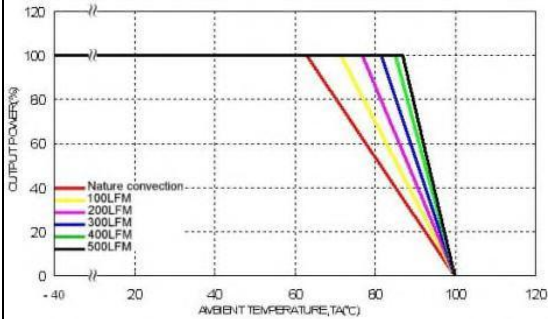
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



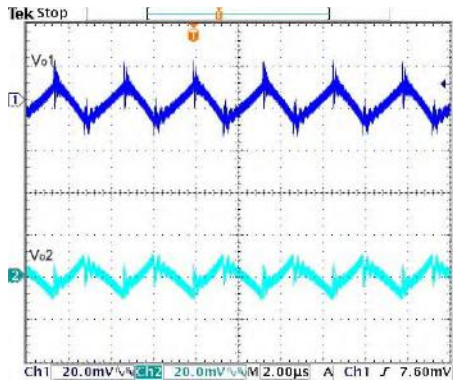
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



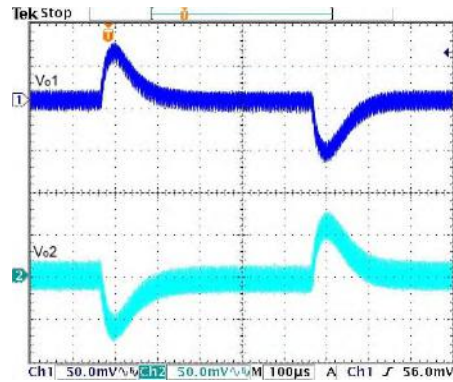
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

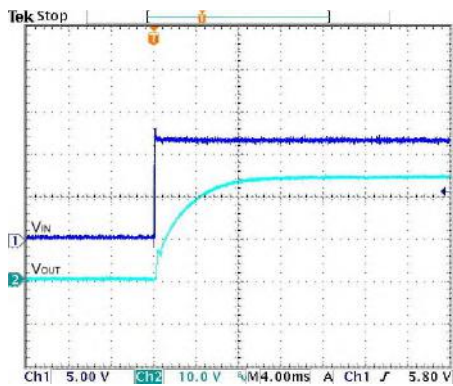
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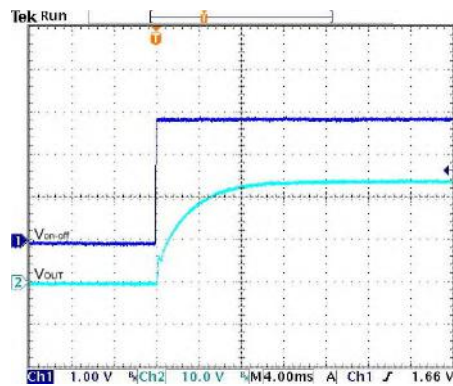
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



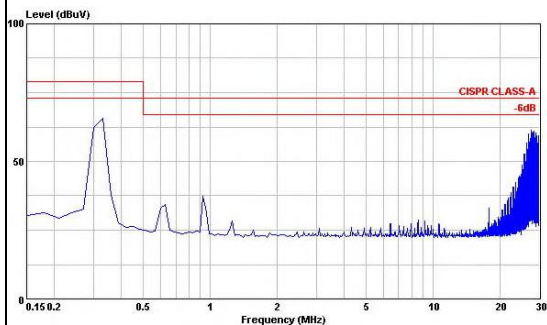
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



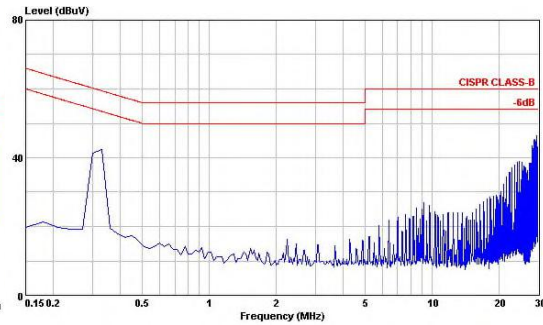
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



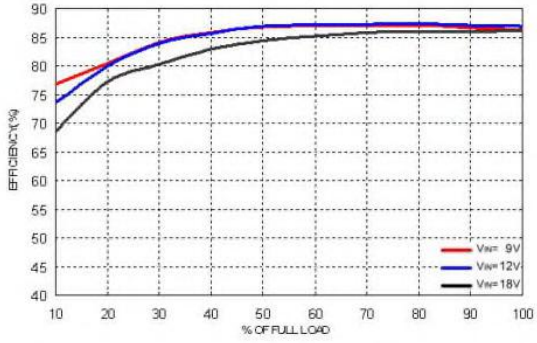
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



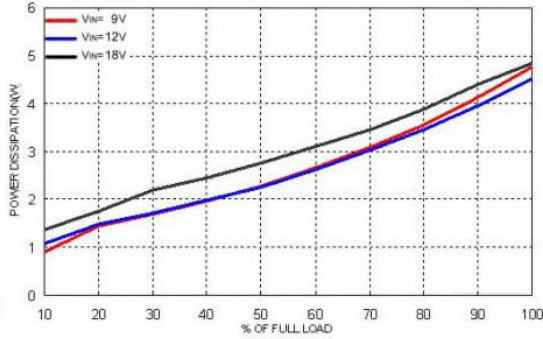
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

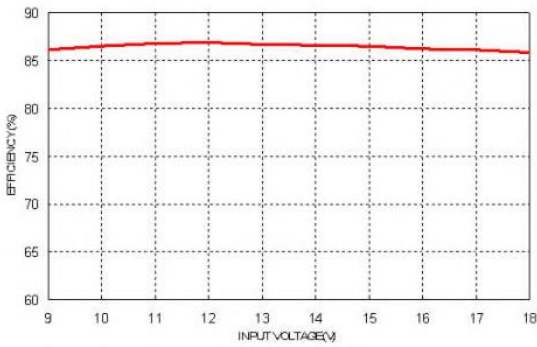
All test conditions are at 25°C. The figures are for PXE30-12D15



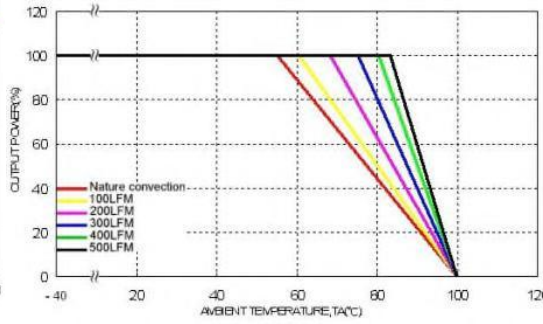
Efficiency Versus Output Current



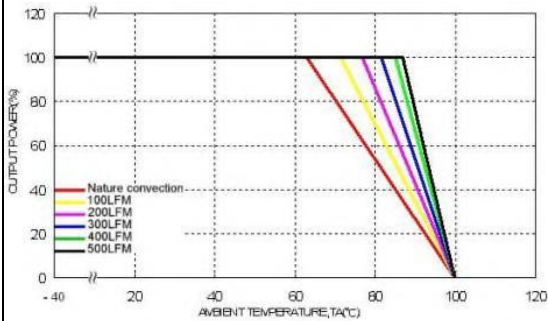
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



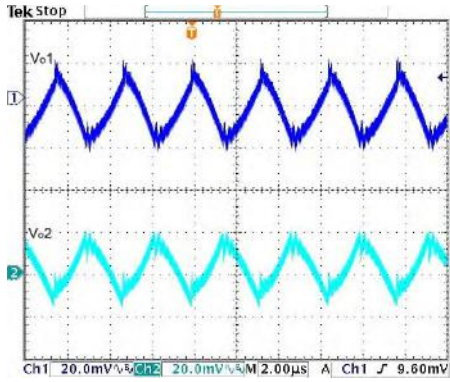
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



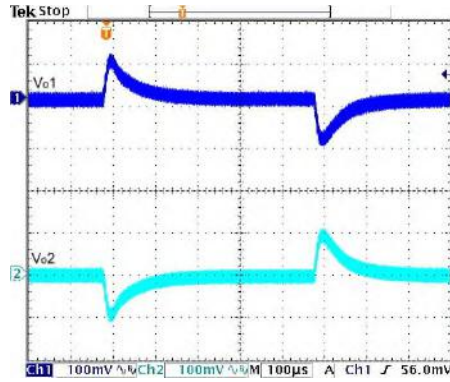
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

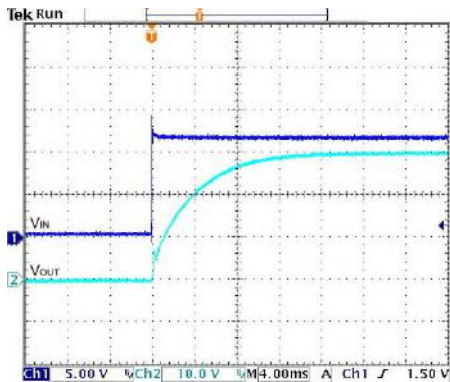
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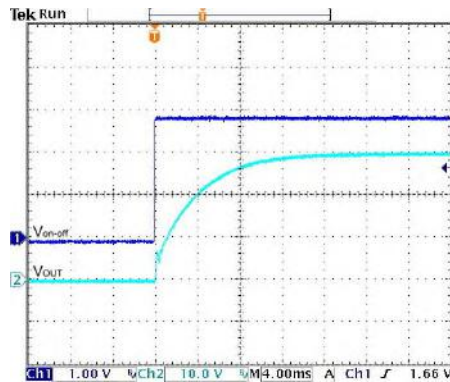
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



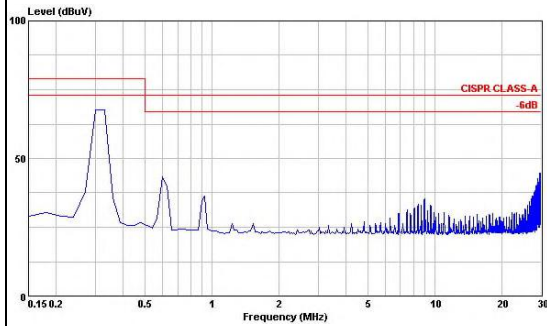
Transient Response to Dynamic Load Change from
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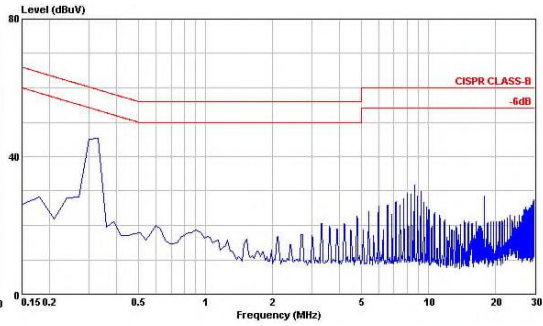
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
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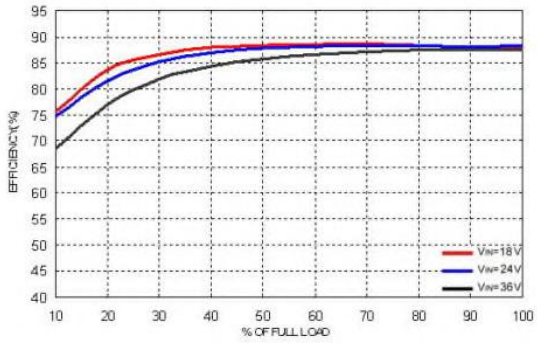
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



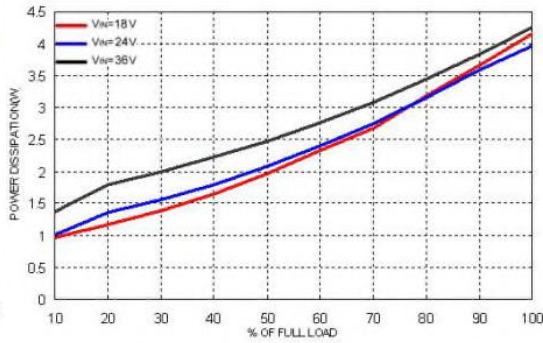
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

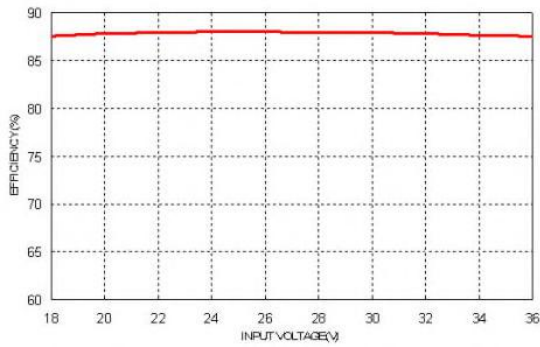
All test conditions are at 25°C. The figures are for PXE30-24D12



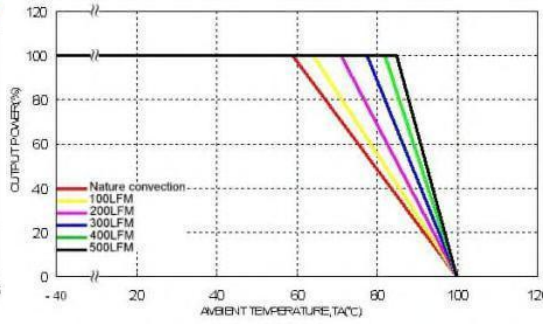
Efficiency Versus Output Current



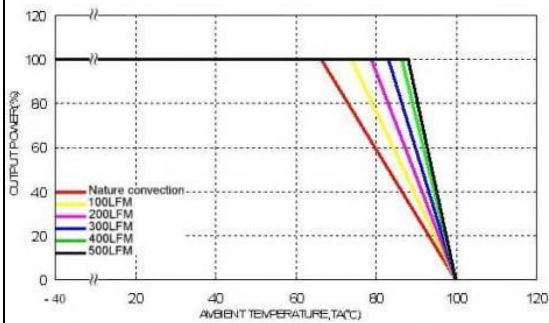
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



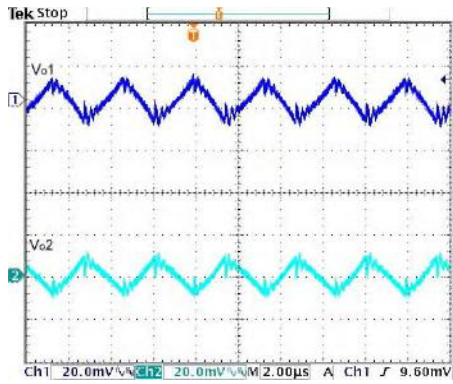
Derating Output Current Versus Ambient Temperature and Airflow V_{in}=V_{in}(nom)



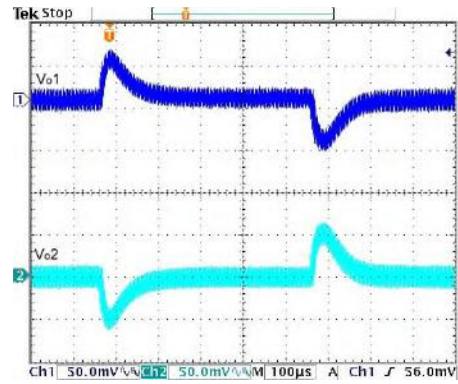
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, V_{in} = V_{in}(nom)

Characteristic Curves (Continued)

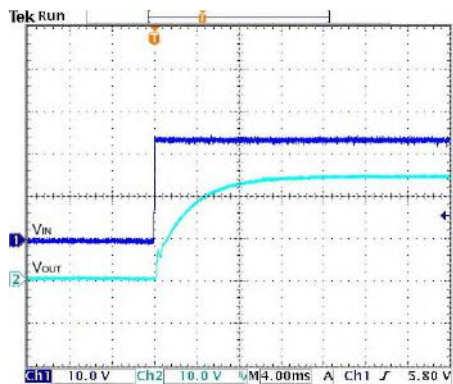
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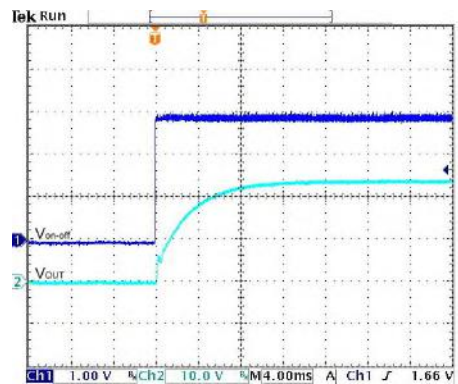
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



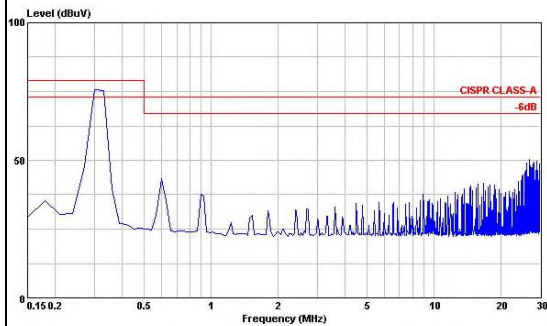
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



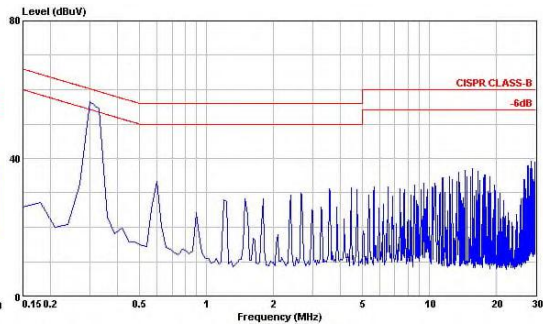
Typical Input Start-Up and Output Rise Characteristic
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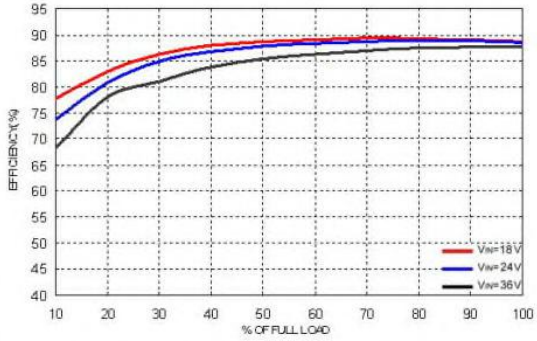
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



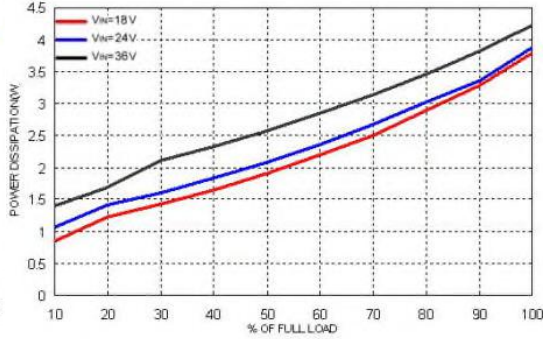
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

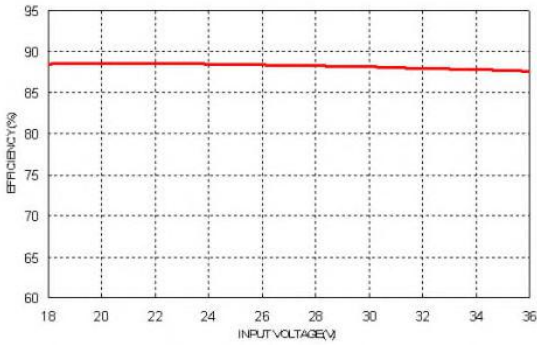
All test conditions are at 25°C. The figures are for PXE30-24D15



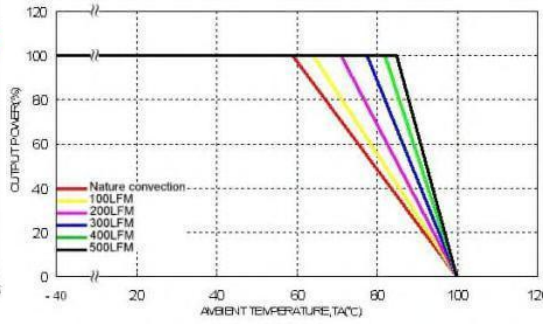
Efficiency Versus Output Current



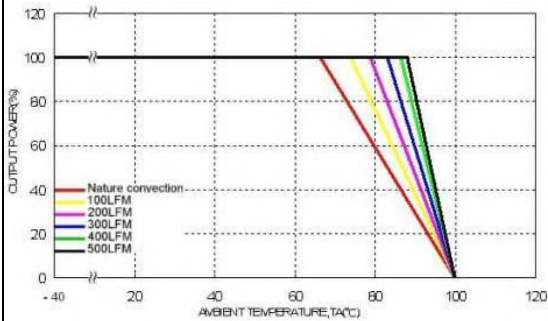
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



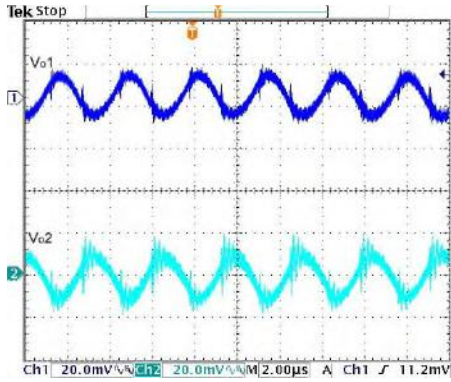
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



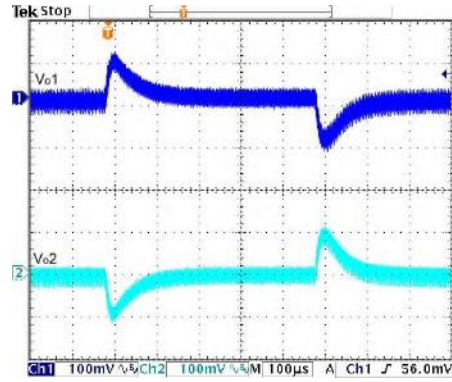
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

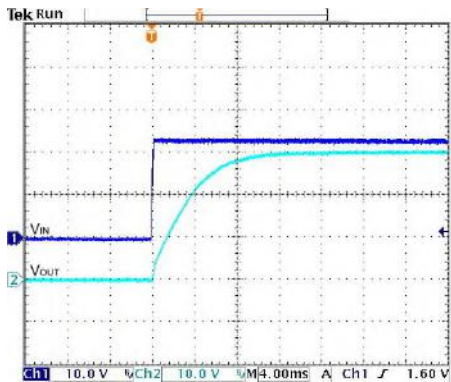
All test conditions are at 25°C. The figures are for PXE30-24D15



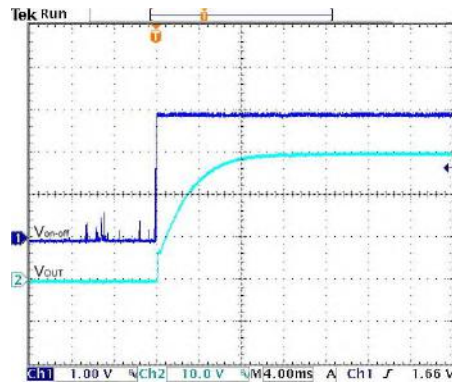
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



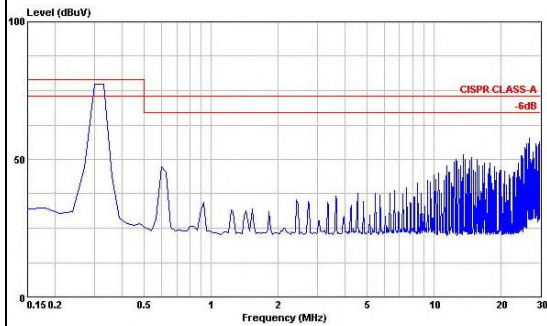
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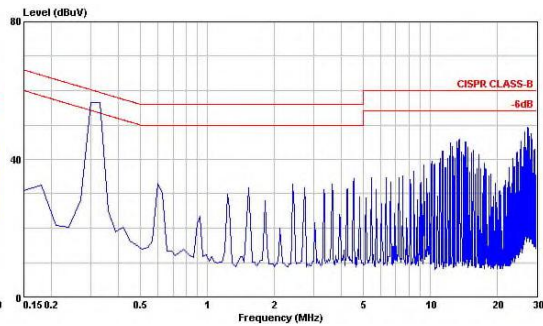
Typical Input Start-Up and Output Rise Characteristic
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Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
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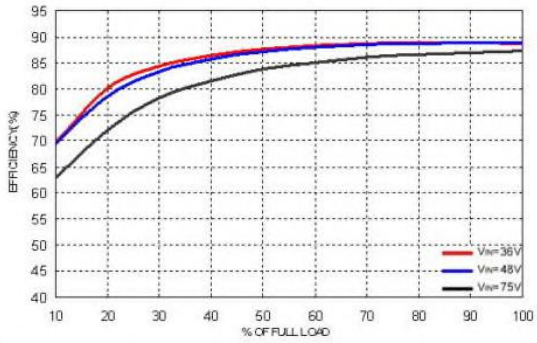
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



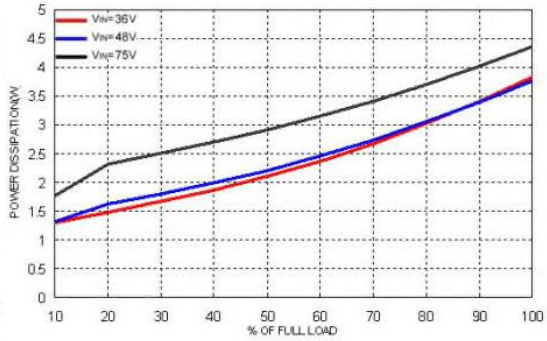
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

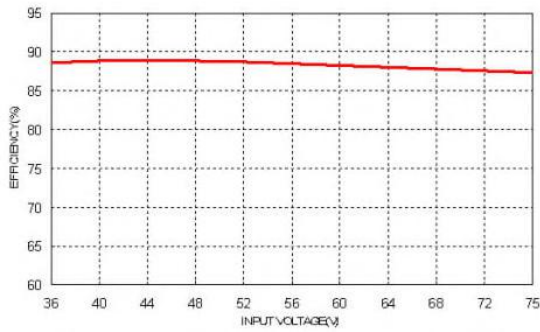
All test conditions are at 25°C. The figures are for PXE30-48D12



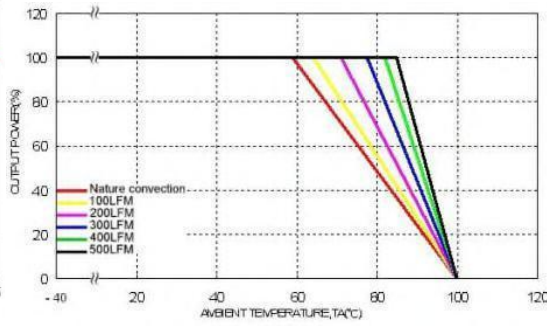
Efficiency Versus Output Current



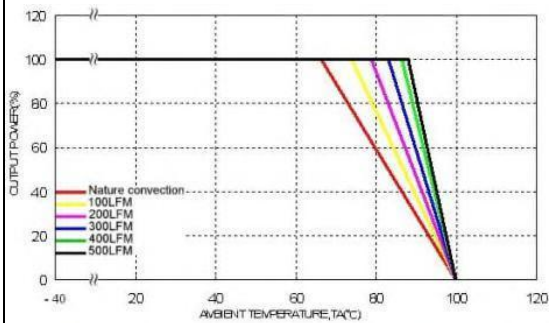
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



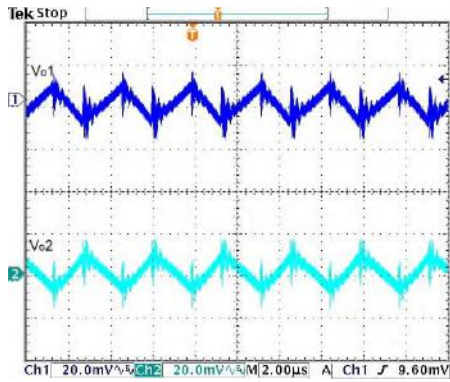
Derating Output Current Versus Ambient Temperature and Airflow $V_{in}=V_{in}(nom)$



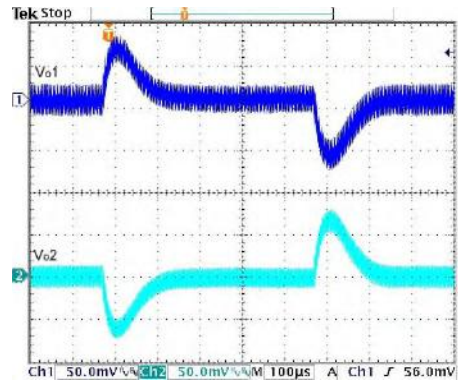
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, $V_{in} = V_{in}(nom)$

Characteristic Curves (Continued)

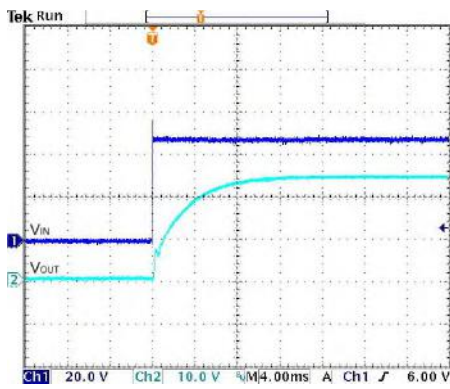
All test conditions are at 25°C. The figures are for PXE30-48D12



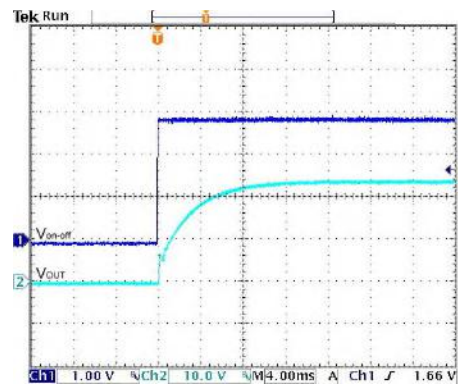
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



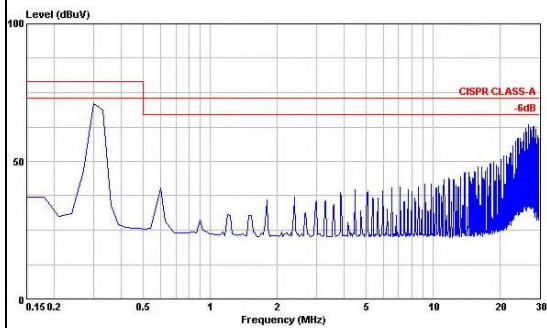
Transient Response to Dynamic Load Change from
100% to 75% to 100% of Full Load ; Vin=Vin(nom)



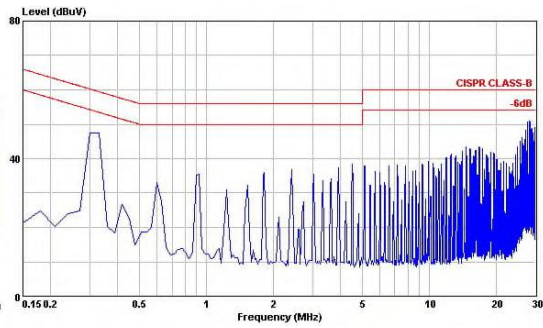
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



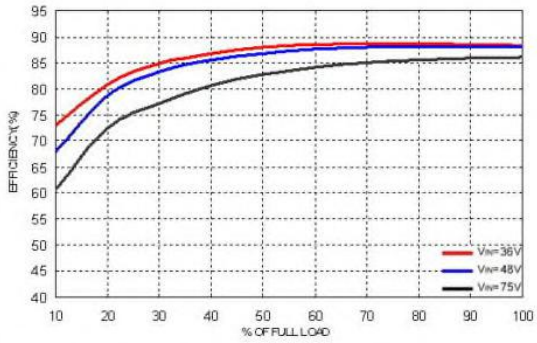
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



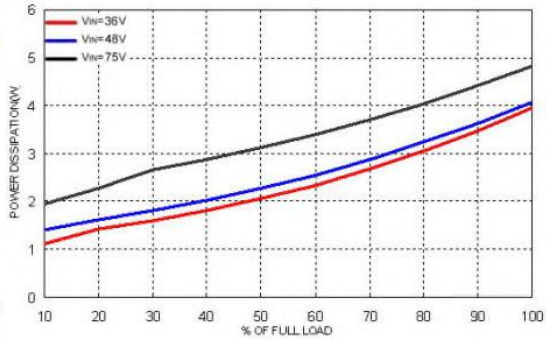
Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

Characteristic Curves (Continued)

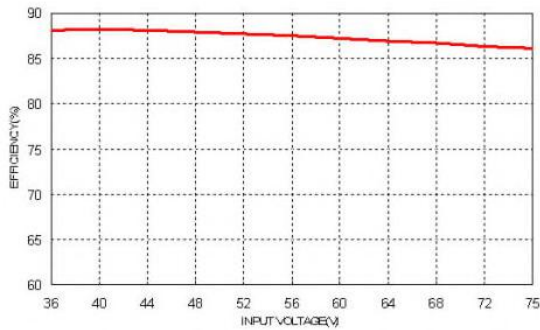
All test conditions are at 25°C. The figures are for PXE30-48D15



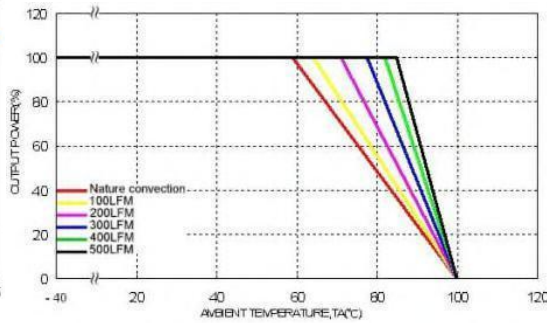
Efficiency Versus Output Current



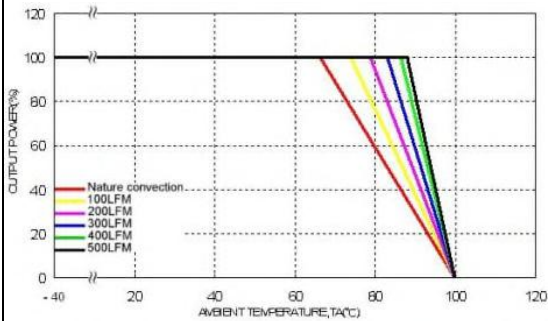
Power Dissipation Versus Output Current



Efficiency Versus Input Voltage. Full Load



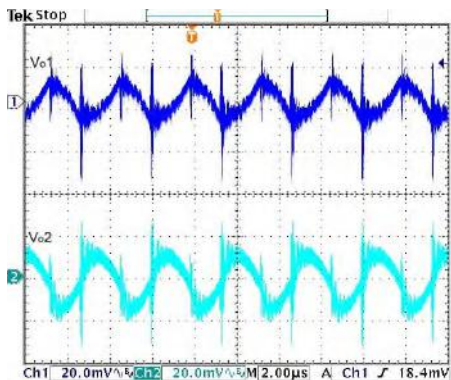
Derating Output Current Versus Ambient Temperature and Airflow Vin=Vin(nom)



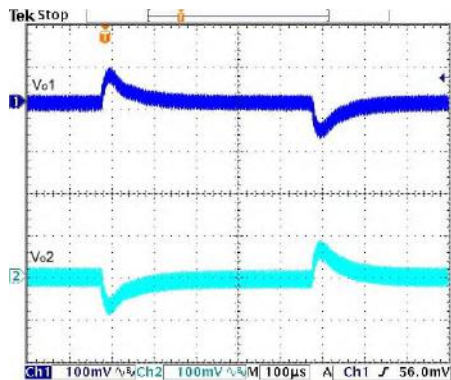
Derating Output Current Versus Ambient Temperature with Heat-Sink and Airflow, Vin = Vin(nom)

Characteristic Curves (Continued)

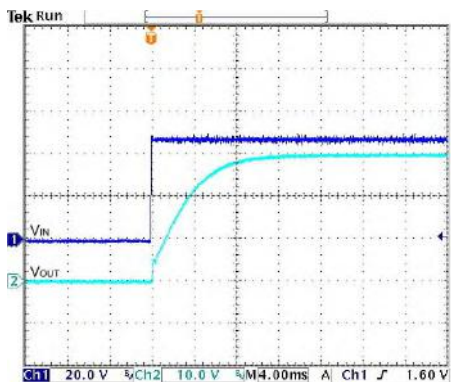
All test conditions are at 25°C. The figures are for PXE30-48D15



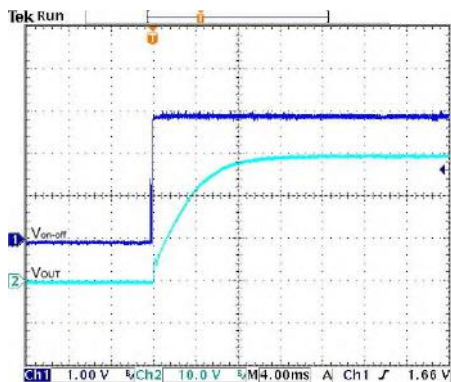
Typical Output Ripple and Noise.
Vin=Vin(nom), Full Load



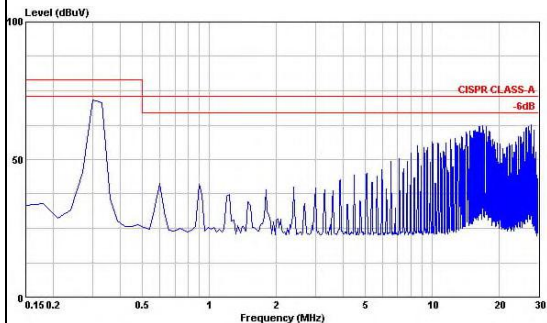
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load ; Vin=Vin(nom)



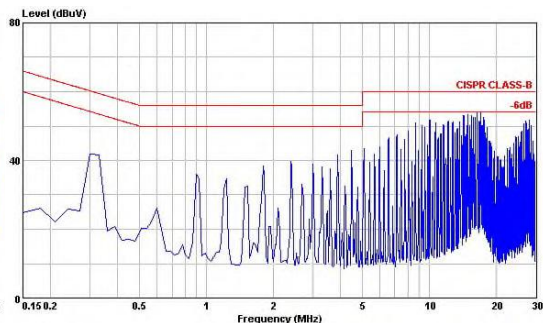
Typical Input Start-Up and Output Rise Characteristic
Vin=Vin(nom), Full Load



Using ON/OFF Voltage Start-Up and Vo Rise Characteristic
Vin=Vin(nom), Full Load



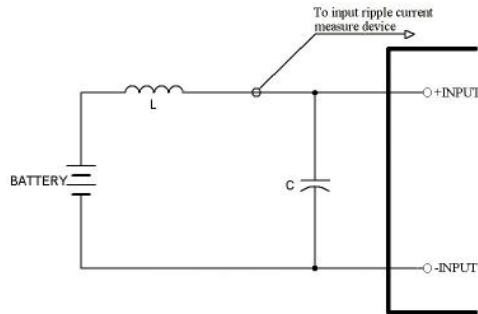
Conduction Emission of EN55022 Class A
Vin=Vin(nom), Full Load



Conduction Emission of EN55022 Class B
Vin=Vin(nom), Full Load

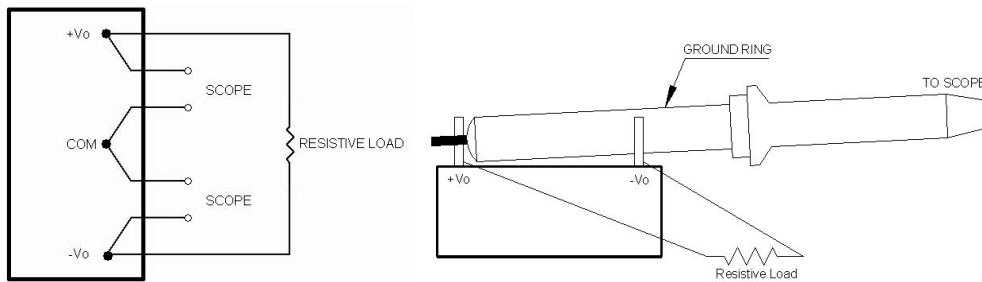
Test Configurations

Input reflected-ripple current measurement test:

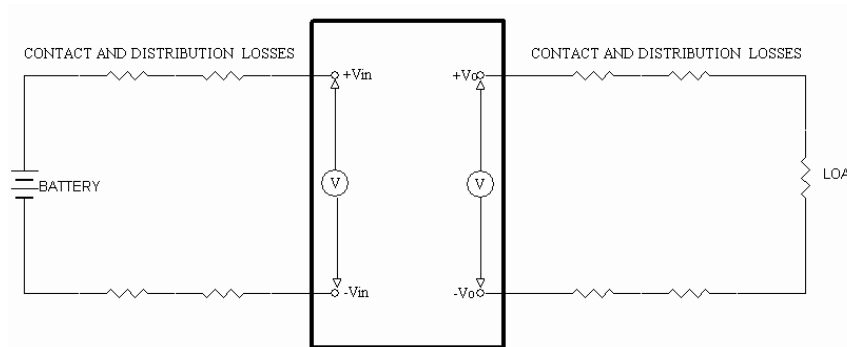


| Component | Value | Voltage | Reference |
|-----------|-------|---------|---------------------------------|
| L | 12μH | --- | --- |
| C | 220μF | 100V | Aluminum Electrolytic Capacitor |

Peak-to-peak output ripple & noise measurement test:



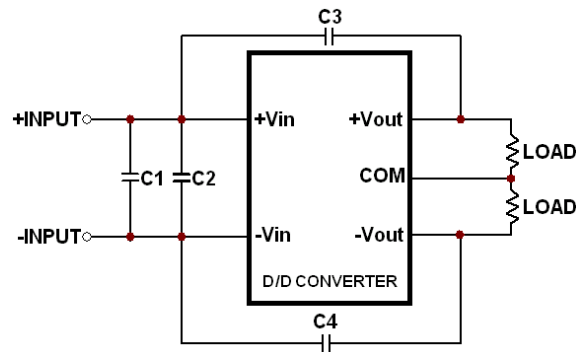
Output voltage and efficiency measurement test:



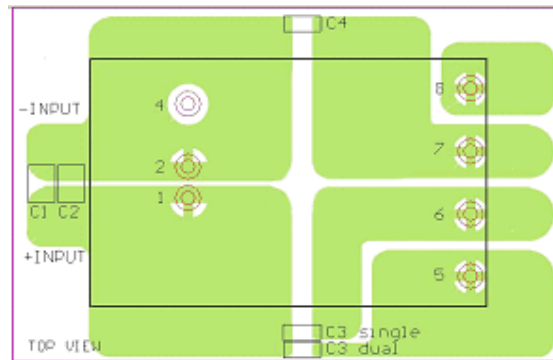
Note: All measurements are taken at the module terminals.

$$Efficiency = \left(\frac{V_o \times I_o}{V_{in} \times I_{in}} \right) \times 100\%$$

EMC Considerations



Suggested Schematic for EN55022 Conducted Emission Class A Limits



Recommended Layout with Input Filter

To meet conducted emissions EN 55022 CLASS A the following components are needed:

PXE30-12Dxx

| Component | Value | Voltage | Reference |
|-----------|-------------|---------|-----------|
| C1 | 6.8 μ F | 50V | 1812 MLCC |
| C3 - C4 | 1000pF | 2KV | 1808 MLCC |

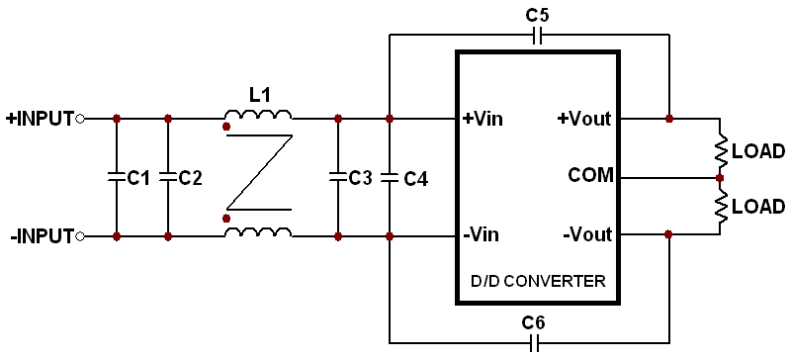
PXE30-24Dxx

| Component | Value | Voltage | Reference |
|-----------|-------------|---------|-----------|
| C1 | 6.8 μ F | 50V | 1812 MLCC |
| C3:C4 | 1000pF | 2KV | 1808 MLCC |

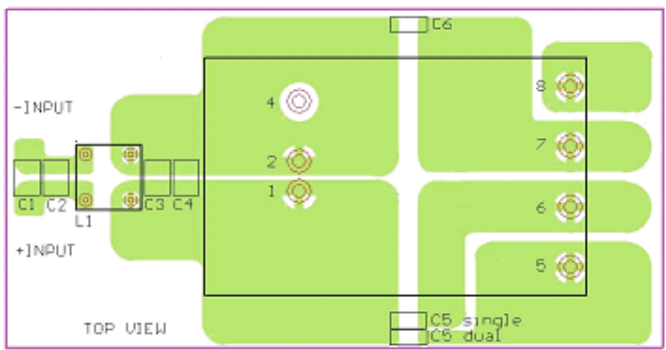
PXE30-48Dxx

| Component | Value | Voltage | Reference |
|-----------|-------------|---------|-----------|
| C1 | 2.2 μ F | 100V | 1812 MLCC |
| C3:C4 | 1000pF | 2KV | 1808 MLCC |

EMC Considerations (Continued)



Suggested Schematic for EN55022 Conducted Emission Class B Limits



Recommended Layout with Input Filter

To meet conducted emissions EN55022 CLASS B needed the following components :

PXE30-12Dxx

| Component | Value | Voltage | Reference |
|-----------|--------|---------|--------------|
| C1:C3 | 4.7µF | 50V | 1812 MLCC |
| C5:C6 | 1000pF | 2KV | 1808 MLCC |
| L1 | 450µH | ---- | Common Choke |

PXE30-24Dxx

| Component | Value | Voltage | Reference |
|-----------|--------|---------|--------------|
| C1:C3 | 6.8µF | 50V | 1812 MLCC |
| C5:C6 | 1000pF | 2KV | 1808 MLCC |
| L1 | 450µH | ---- | Common Choke |

PXE30-48Dxx

| Component | Value | Voltage | Reference |
|-----------|--------|---------|--------------|
| C1:C2 | 2.2µF | 100V | 1812 MLCC |
| C3:C4 | 2.2µF | 100V | 1812 MLCC |
| C5:C6 | 1000pF | 2KV | 1808 MLCC |
| L1 | 450µH | ---- | Common Choke |

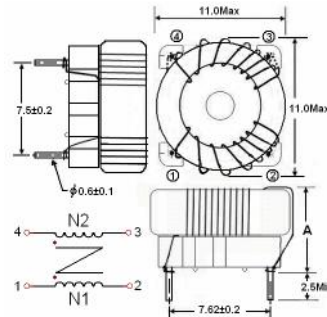
EMC Considerations (Continued)

This Common Choke L1 is defined as follows:

■ L:450 μ H \pm 35% / DCR:25m Ω , max

■ A height:9.8 mm, Max

■ All dimensions in millimeters



Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Input external L-C filter is recommended to minimize input reflected ripple current. The inductor has a simulated source impedance of 12 μ H and capacitor is Nippon chemi-con KY series 220 μ F/100V. The capacitor must as close as possible to the input terminals of the power module for lower impedance.

Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all converters. Normally, overload current is maintained at approximately 150 percent of rated current for PXF40-xxSxx series.

Hiccup-mode is a method of operation in a converter whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the converter to restart when the fault is removed. There are other ways of protecting the converter when it is over-loaded, such as the maximum current limiting or current foldback methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of these devices may exceed their specified limits. A protection mechanism has to be used to prevent these power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the converter for a given time and then tries to start up the converter again. If the over-load condition has been removed, the converter will start up and operate normally; otherwise, the controller will see another over-current event and will shut off the converter again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

Output Over Voltage Protection

The output over-voltage protection consists of a Zener diode that monitors the voltage on the output terminals. If the voltage on the output terminals exceeds the over-voltage protection threshold, then the Zener diode clamps the output voltage.

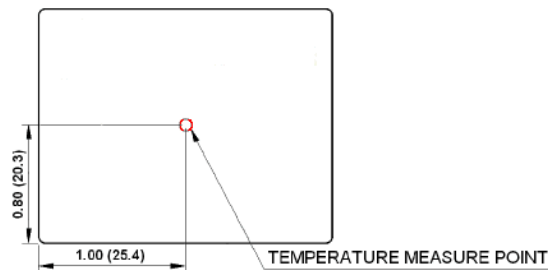
Short Circuit Protection

Continuous, hiccup and auto-recovery mode.

During a short circuit, the converter shut s down. The average current during this condition will be very low .

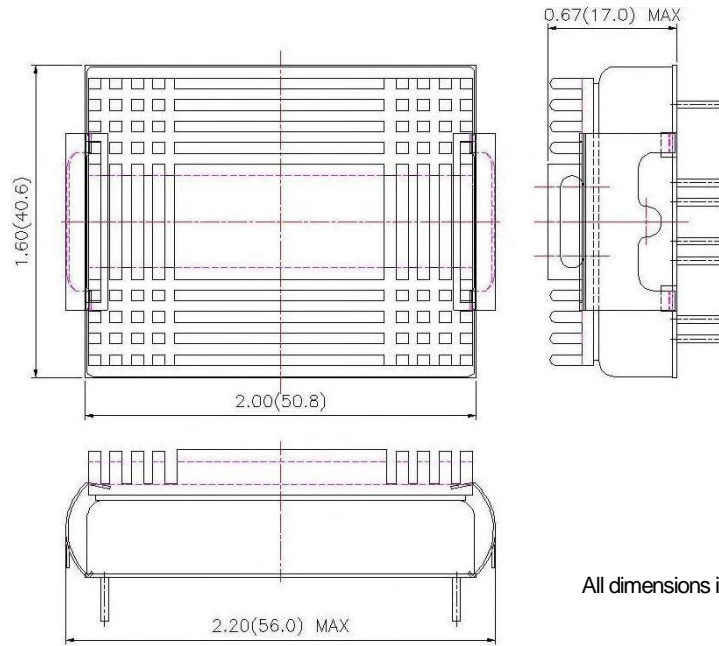
Thermal Consideration

The power module operates in a variety of thermal environments. However, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 100°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 100°C. Although the maximum point temperature of the power modules is 100°C, limiting this temperature to a lower value will yield higher reliability.



Heat Sink Consideration

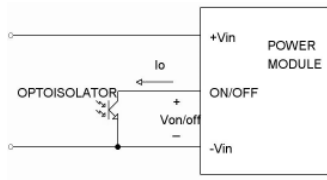
Optional heat-sink (HAPXE) and optional heat sink clip (HAPXECLIP); two clips required when used.



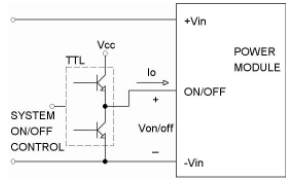
Remote ON/OFF Control

The Remote ON/OFF Pin is used to turn on and off the DC/DC power module. The user must use a switch to control the logic voltage (high or low level) of the pin referenced to -Vin. The switch can be an open collector transistor, FET and Opto-Coupler. The switch must be capable of sinking up to 0.5 mA at low-level logic voltage. High-level logic of the ON/OFF signal (maximum voltage): the allowable leakage current of the switch at 12V is 0.5mA.

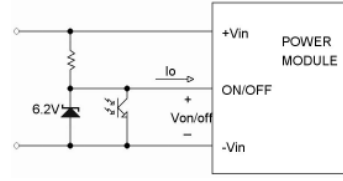
Remote ON/OFF Implementation Circuits



Isolated-Clontrol Remote ON/OFF

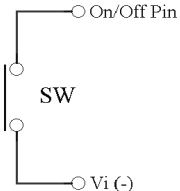


Level Control Using TTL Output

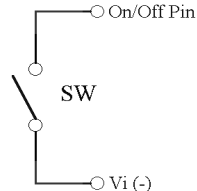


Level Control Using Line Voltage

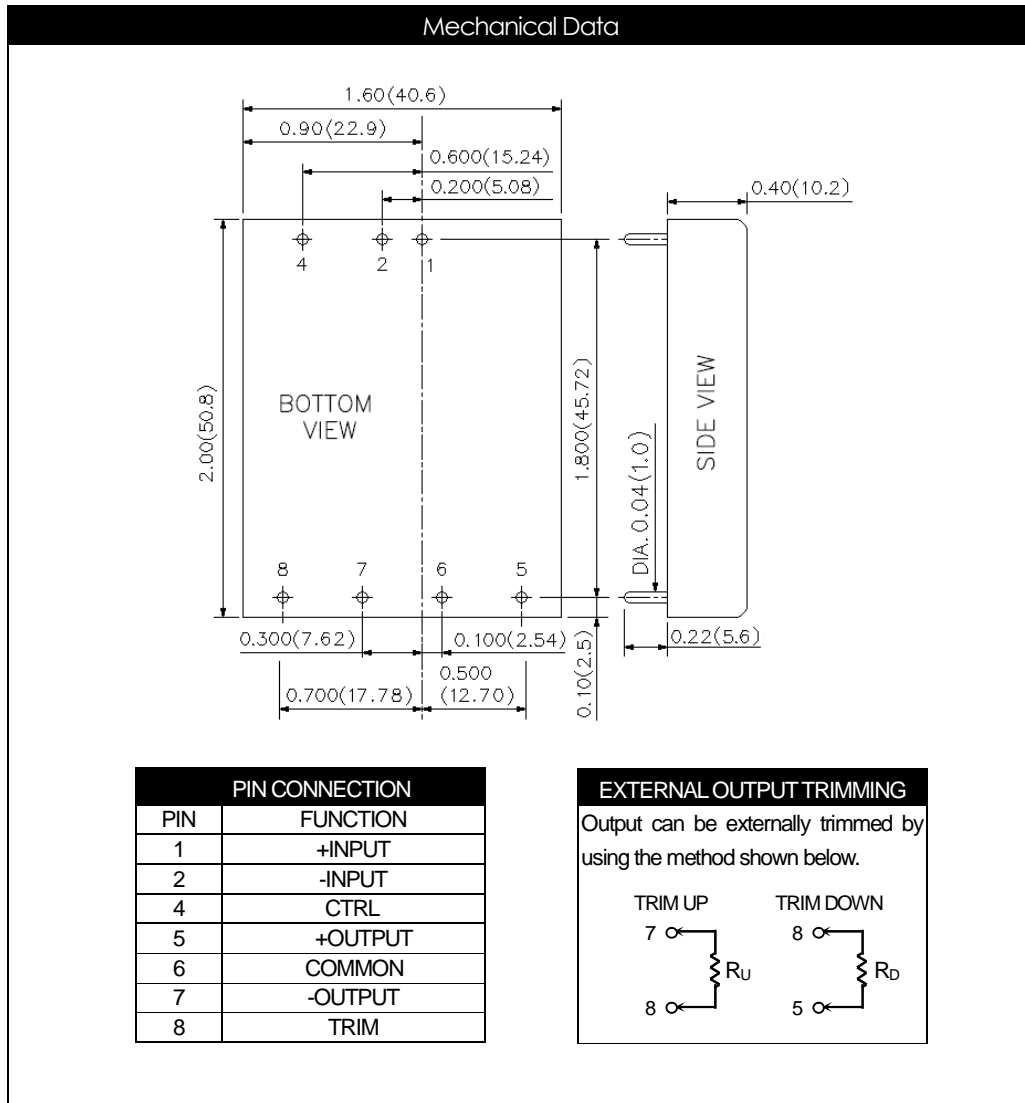
Positive Logic:

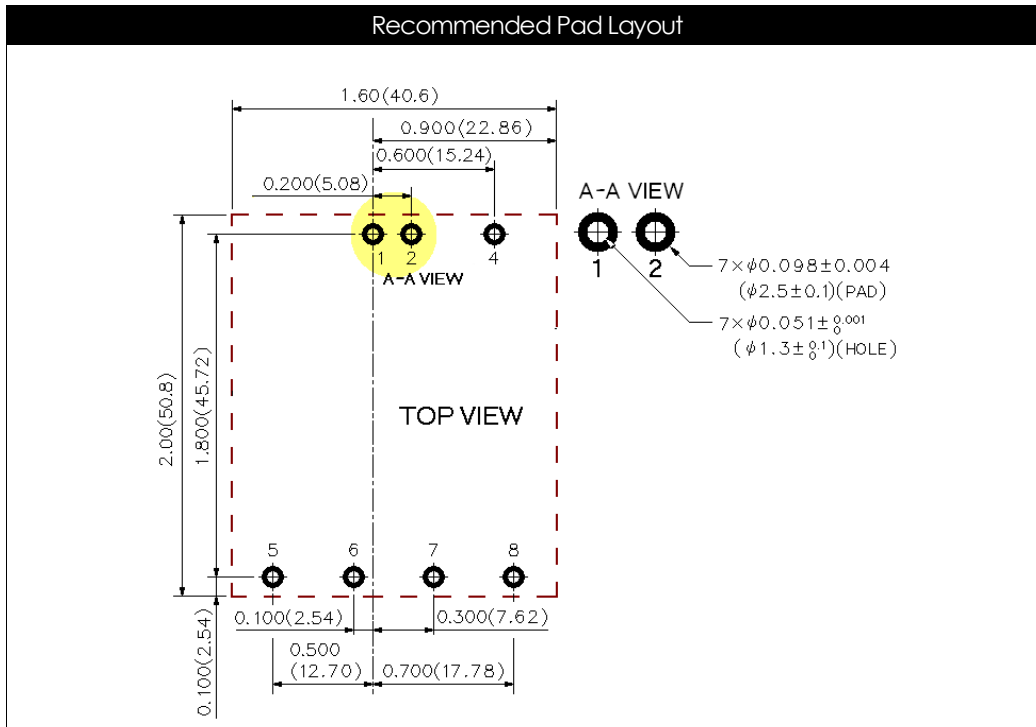


When PXE30 module is turned off at Low-level logic



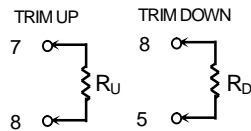
When PXE30 module is turned on at High-level logic





Output Voltage Adjustment

Output voltage set point adjustment allows the user to increase or decrease the output voltage set point of a module. This is accomplished by connecting an external resistor between the TRIM pin and either the Vo(+) or Vo(-) pins. With an external resistor between the TRIM and Vo(-) pin, the output voltage set point increases. With an external resistor between the TRIM and Vo(+) pin, the output voltage set point decreases.



TRIM TABLE

PXE30-xxD12

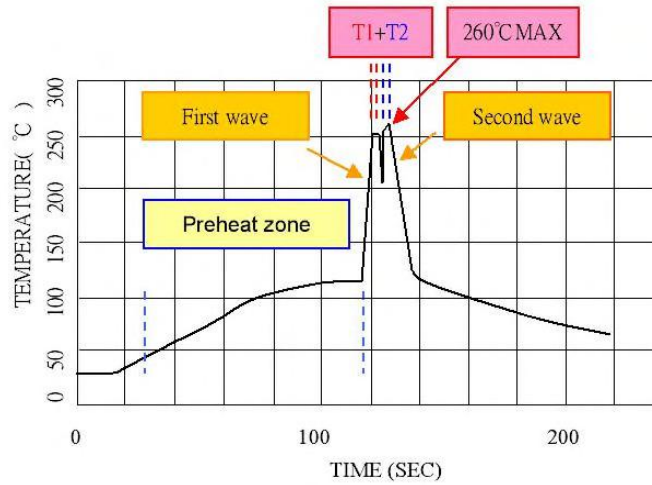
| Trim up (%) | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
|---------------------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|-------|
| V _{OUT} (Volts)= | ±12.12 | ±12.24 | ±12.36 | ±12.48 | ±12.6 | ±12.72 | ±12.84 | ±12.96 | ±13.08 | ±13.2 |
| R _U (K OhmS)= | 218.21 | 98.105 | 58.07 | 38.052 | 26.042 | 18.035 | 12.316 | 8.026 | 4.69 | 2.021 |
| Trim down (%) | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
| V _{OUT} (Volts)= | ±11.88 | ±11.76 | ±11.64 | ±11.52 | ±11.4 | ±11.28 | ±11.16 | ±11.04 | ±10.92 | ±10.8 |
| R _D (K OhmS)= | 273.44 | 123.02 | 72.874 | 47.803 | 32.76 | 22.732 | 15.568 | 10.196 | 6.017 | 2.675 |

PXE30-xxD15

| Trim up (%) | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
|---------------------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|-------|
| V _{OUT} (Volts)= | ±15.15 | ±15.3 | ±15.45 | ±15.6 | ±15.75 | ±15.9 | ±16.05 | ±16.2 | ±16.35 | ±16.5 |
| R _U (K OhmS)= | 268.29 | 120.64 | 71.429 | 46.822 | 32.058 | 22.215 | 15.184 | 9.911 | 5.81 | 2.529 |
| Trim down (%) | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
| V _{OUT} (Volts)= | ±14.85 | ±14.7 | ±14.55 | ±14.4 | ±14.25 | ±14.1 | ±13.95 | ±13.8 | ±13.65 | ±13.5 |
| R _D (K OhmS)= | 337.71 | 152.02 | 90.126 | 59.178 | 40.609 | 28.23 | 19.387 | 12.756 | 7.598 | 3.471 |

Soldering and Reflow Consideration

Lead free wave solder profile for PXE30-xxDxx DIP type



| Zone | Reference Parameter |
|----------------|----------------------------------------------------------------|
| Preheat zone | Rise temp. speed : 3°C / sec max. Preheat temp. : 100~130°C |
| Actual heating | Peak temp. : 250~260°C Peak time (T1+T2 time) : 4~6 sec |

Reference Solder: Sn-Ag-Cu/Sn-Cu

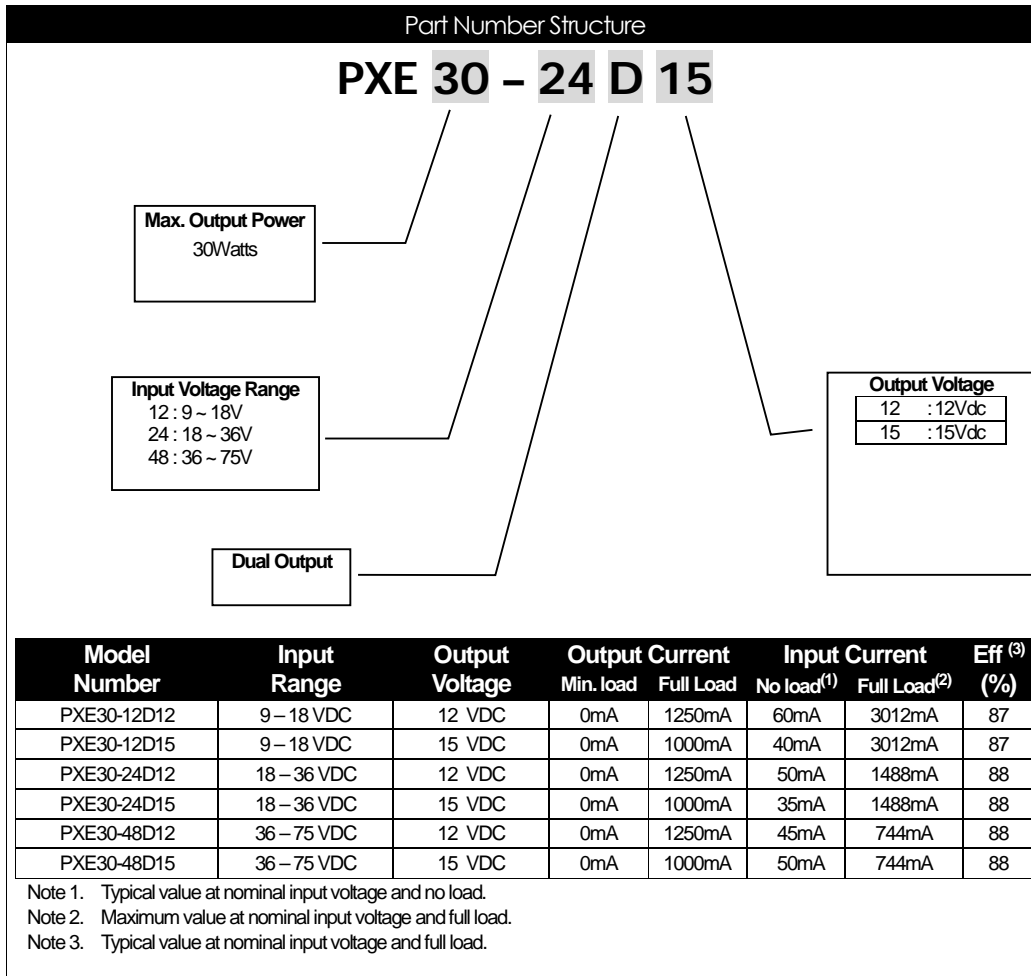
Hand Welding: Soldering iron-Power 90W

Welding Time: 2-4 sec

Temp.: 380-400 °C

Packaging Information

12 PCS per TUBE



Safety and Installation Instruction

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a slow-blow fuse with maximum rating of 6A. Based on the information provided in this data sheet on Inrush energy and maximum DC input current; the same type of fuse with lower rating can be used. Refer to the fuse manufacturer's data for further information.

MTBF and Reliability

The MTBF of PXE30-xxDxx DC/DC converters has been calculated using:

Bellcore TR-NWT-000332 Case I: 50% stress, Operating Temperature at 40°C (Ground fixed and controlled environment). The resulting figure for MTBF is 1.316×10⁶ hours.

MIL-HDBK-217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 3.465×10⁵ hours.